EClamp2455P ESD/EMI Protection for SIM Card

PROTECTION PRODUCTS - EMIClamp™

Description

The EClamp[™]2455P is combination EMI filter and line termination device with integrated TVS diodes for use on SIM Card interfaces on cellular phones and other portable electronics. This state-of-the-art device utilizes solid-state silicon-avalanche technology for superior clamping performance and DC electrical characteristics.

The device consists of three circuits that include series impedance matching resistors for proper termination of the SIM card interface. Termination resistor value of 100 Ohms is included on the RST and Data lines and 47 Ohms on the CLK line. TVS diodes are also included on each line for ESD protection in excess of ± 15 kV (air discharge) and ± 8 kV (contact discharge) per IEC 61000-4-2, level 4. An additional TVS diode connection is included for protection of the voltage (Vcc) bus.

The EClamp2455P is in a 8-pin, RoHS/WEEE compliant, SLP2116P8 package. It measures 2.1 x 1.6 x 0.58mm. The leads are spaced at a pitch of 0.5mm and are finished with lead-free NiPdAu. The small package makes it ideal for use in portable electronics such as cell phones and digital still cameras.

Features

- Bidirectional EMI/RFI filter with integrated TVS for ESD protection
- ◆ ESD protection to IEC 61000-4-2 (ESD) Level 4, ±15kV (air), ±8kV (contact)
- ◆ TVS working voltage: 5V
- ◆ Termination Resistors: 100 Ohms & 47 Ohms
- ◆ Capacitance: 20pF (Typical at VR = 0V)
- Protection and filtering for four lines
- Solid-state technology

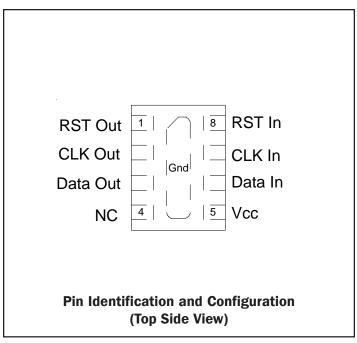
Mechanical Characteristics

- ◆ SLP2116P8 8-pin package
- ◆ RoHS/WEEE Compliant
- ♦ Nominal Dimensions: 2.1 x 1.6 x 0.58 mm
- ◆ Lead Pitch: 0.5mm
- Lead finish: NiPdAu
- Marking: Marking Code
- Packaging: Tape and Reel per EIA 481

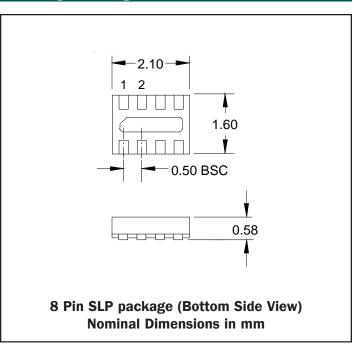
Applications

- SIM Card
- Cell Phone
- PDAs and Smartphones

Pin Configuration



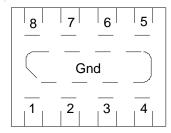
Package Configuration





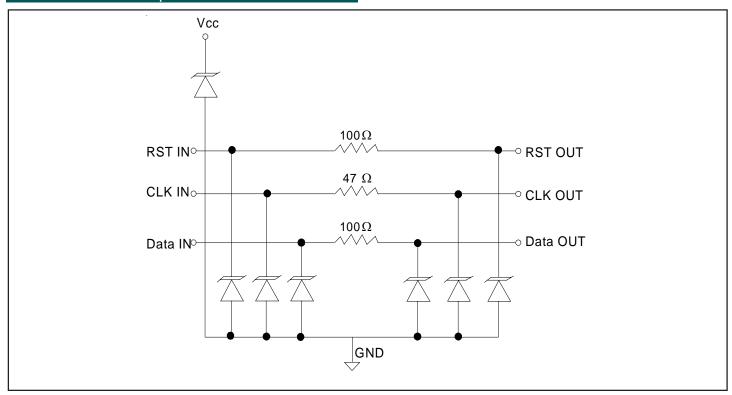
Pin Identification and Configuration

Pin	Symbol	Identification
1, 8	RST	Reset input/output with termination resistor
2, 7	CLK	Clock input/output with termination resistor
3, 6	Data	Data input/output with termination resistor
4	NC	No Connect
5	Vcc	Power Supply ESD Protection
Center tab	GND	Ground connection



Pin Configuration (Top View)

Schematics & Component Values





Maximum Ratings

Rating	Symbol	Value	Units	
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	+/- 18 +/- 12	kV	
Junction Temperature	T _J	125	°C	
Operating Temperature	T _{op}	-40 to +85	°C	
Storage Temperature	T _{STG}	-55 to +150	°C	

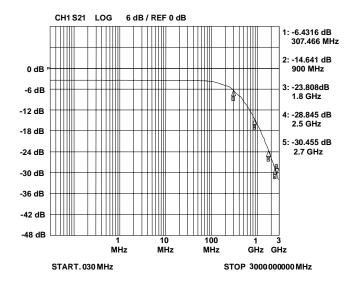
Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
TVS Reverse Stand-Off Voltage	$V_{_{\mathrm{RWM}}}$				5	٧
TVS Reverse Breakdown Voltage	V_{BR}	I _t = 1mA	6	8	10	٧
TVS Reverse Leakage Current	I _R	V _{RWM} = 5.0V		0.1	0.5	μΑ
Reset Series Resistors	R _{RST}	Each Line	85	100	115	Ohms
Clk Series Resistors	R _{CLK}	Each Line	40	47	55	Ohms
Data Series Resistors	R _{DATA}	Each Line	85	100	115	Ohms
Total Capacitance	C_{in}	Input to Gnd, Each Line V _R = 0V, f = 1MHz	16	20	24	pF

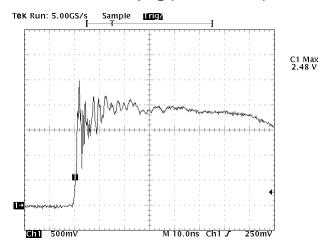


Typical Characteristics

Typical Insertion Loss S21 (Pin 2 to 7)

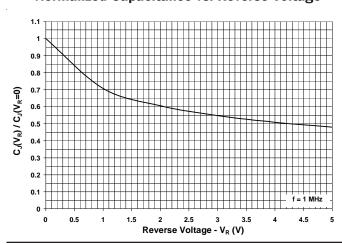


ESD Clamping (+8kV Contact)

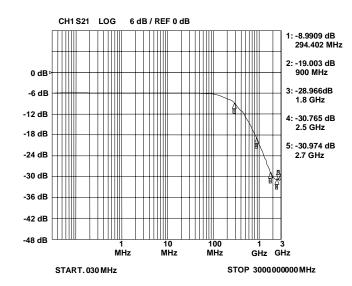


Note: Data is taken with a 10x attenuator

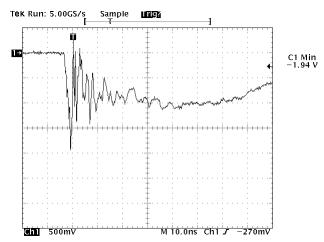
Normalized Capacitance vs. Reverse Voltage



Typical Insertion Loss S21 (Pin 1 to 8 and Pin 3 to 6)

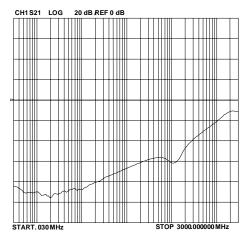


ESD Clamping (-8kV Contact)



Note: Data is taken with a 10x attenuator

Analog Crosstalk (Each Line)

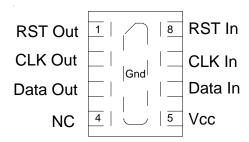


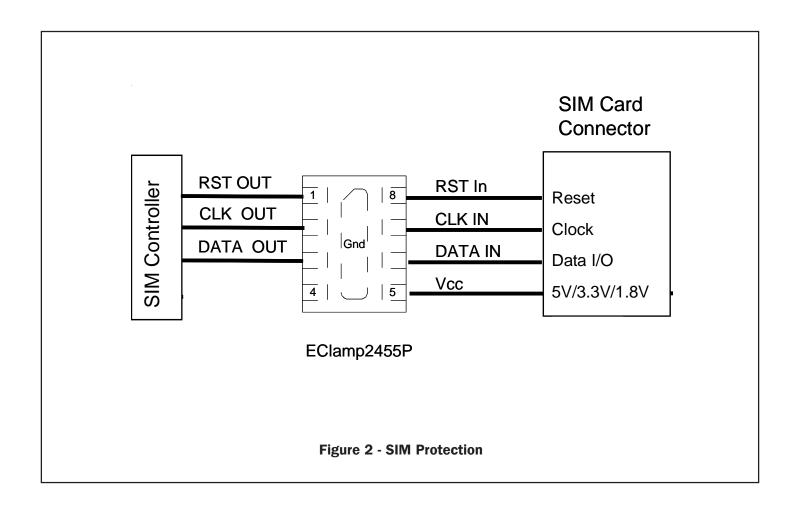


Device Connection

The EClamp2455P designed with ease of layout in mind. The package has flow through design which allows the designer to route the signals straight in and out between the SIM port connector and the SIM controller. The device is in a 8-pin SLP package. Electrical connection is made to the 8 pins located at the bottom of the device. A center tab serves as the ground connection. Pin connections are noted in Figure 1. All path lengths should be kept as short as possible to minimize the effects of parasitic inductance in the board traces.

Figure 1 - Pin Identification and Configuration (Top Side View)







Applications Information - Spice Model

EClamp2455P Spice Model & Parameters

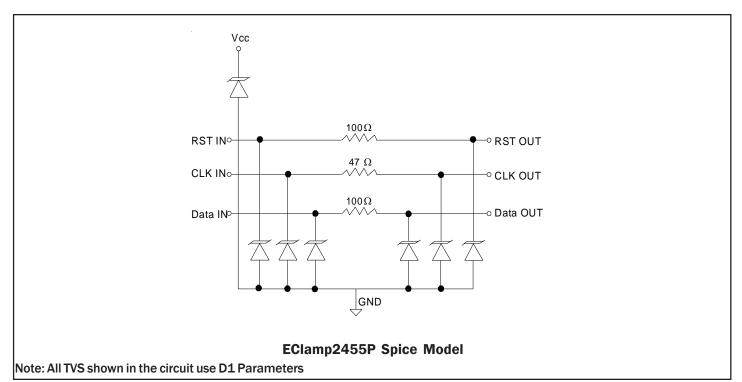
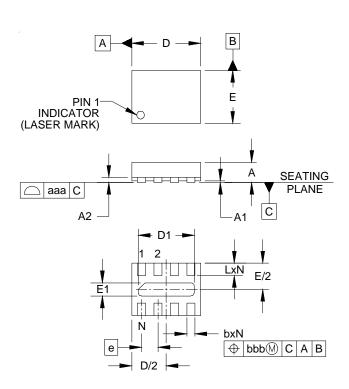


Table 1 - EClamp2455P Spice Parameters							
Parameter	Unit	D1 (TVS)					
IS	Amp	2E-15					
BV	Volt	7.5					
VJ	Volt	0.775					
RS	Ohm 1						
IBV	Amp	1E-3					
C10	Farad	9E-12					
TT	sec	2.541E-9					
М		0.246					
N		1.1					
EG	eV	1.11					



Outline Drawing - SLP2116P8

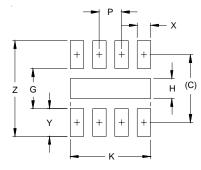


DIMENSIONS								
DIM	11	NCHE	S	MILLIMETERS				
ווועו	MIN	NOM	MAX	MIN	NOM	MAX		
Α	.020	.023	.026	0.50	0.58	0.65		
A1	-	.001	.002	0.00	.003	0.05		
A2		(.005)			(0.13)			
b	.008	.010	.012	0.20	0.25	0.30		
D	.079 .083		.087	2.00	2.10	2.20		
D1	.061	.067	.071	1.55	1.70	1.80		
Е	.059	.063	.067	1.50	1.60	1.70		
E1	.010	.016	.020	0.25	0.40	0.50		
е	.0	20 BS	C	0.50 BSC				
L	.011	.013	.015	0.28	0.33	0.38		
Ν		8		8				
aaa		.003		0.08				
bbb		.004		0.10				

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

Land Pattern - SLP2116P8



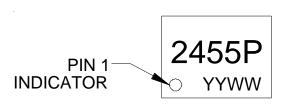
	DIMENSIONS								
DIM	INCHES	NCHES MILLIMETERS (.060) (1.52) .035 0.89 .018 0.45 .071 1.80							
С	(.060)	(1.52)							
G	.035	0.89							
Н	.018	18 0.45							
K	.071	HES MILLIMETERS (60) (1.52) (35 0.89 (18 0.45 (71 1.80 (20 0.50 (12 0.30 (25 0.63							
Р	.020	0.50							
Χ	.012	0.30							
Υ	.025	0.63							
Z	.085	0) (1.52) 5 0.89 8 0.45 1 1.80 0 0.50 2 0.30 5 0.63							

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
- THERMAL VIAS IN THE LAND PATTERN OF THE EXPOSED PAD SHALL BE CONNECTED TO A SYSTEM GROUND PLANE. FAILURE TO DO SO MAY COMPROMISE THE THERMAL AND/OR FUNCTIONAL PERFORMANCE OF THE DEVICE.



Marking



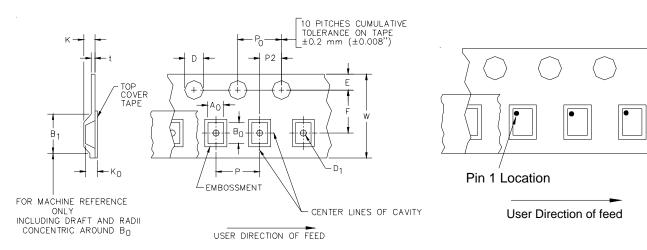
Ordering Information

Part Number	Qty per Reel	Reel Size
EClamp2455P.TCT	3000	7 Inch

This is a lead-free RoHS/WEEE Compliant Device EMIClamp and EClamp are marks of Semtech Corporation

YYWW = Date Code

Tape and Reel Specification



Device Orientation in Tape

A0	В0	ко		
1.96 +/-0.05 mm	2.31 +/-0.05 mm	0.74 +/-0.05 mm		

Tape Width	B, (Max)	D	D1	E	F	K (MAX)	Р	PO	P2	T(MAX)	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm (0.59 +.005 000)	0.8 mm ±0.05 (.031)	1.750±.10 mm (.069±.004)	3.5±0.05 mm (.138±.002)	2.4 mm (.094)	4.0±0.1 mm (.157±.00- 4)	4.0±0.1 mm (.157±.00- 4)	2.0±0.05m- m (.079±.002)	0.4 mm (.016)	8.0 mm + 0.3 mm - 0.1 mm (.312±.012)

Contact Information

Semtech Corporation Protection Products Division 200 Flynn Rd., Camarillo, CA 93012 Phone: (805)498-2111 FAX (805)498-3804

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